

Surface Mount Schottky Barrier Rectifier
Reverse Voltage - 20 to 200 V
Forward Current - 3.0A

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Top View

Simplified outline SMAF and symbol

Features

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

MECHANICAL DATA

- Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 27mg / 0.00095oz

Absolute Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbols	SS32F	SS34F	SS34AF	SS36F	SS38F	SS310F	SS3120F	SS3150F	SS320F	Units
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	20	40	45	60	80	100	120	150	200	V
Maximum RMS voltage	V _{RMS}	14	28	31.5	42	56	70	84	105	140	V
Maximum DC Blocking Voltage	V _{DC}	20	40	45	60	80	100	120	150	200	V
Maximum Average Forward Rectified Current	I _{F(AV)}	3.0									A
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	80									A
Max Instantaneous Forward Voltage at 3 A	V _F	0.55	0.70			0.85		0.95		V	
Maximum DC Reverse Current T _a = 25°C at Rated DC Reverse Voltage T _a =100°C	I _R	0.5 5				0.3 3				mA	
Typical Junction Capacitance ⁽¹⁾	C _j	250				180				pF	
Typical Thermal Resistance ⁽²⁾	R _{θJA} R _{θJC}	70 18									°C/W
Operating Junction Temperature Range	T _j	-55 ~ +150									°C
Storage Temperature Range	T _{stg}	-55 ~ +150									°C

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Fig.1 Forward Current Derating Curve

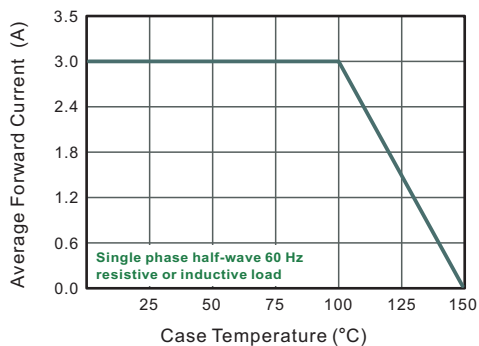


Fig.2 Typical Reverse Characteristics

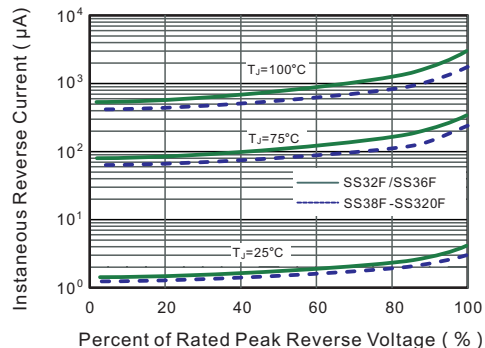


Fig.3 Typical Forward Characteristic

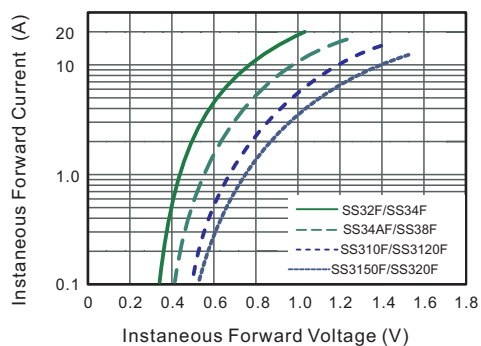


Fig.4 Typical Junction Capacitance

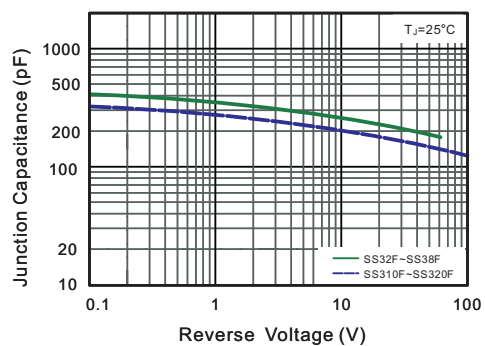


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

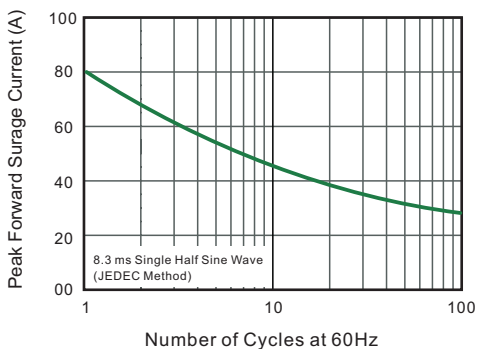
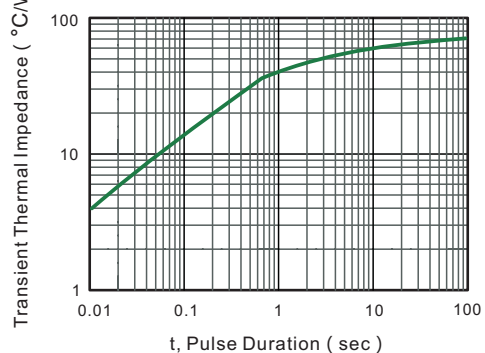
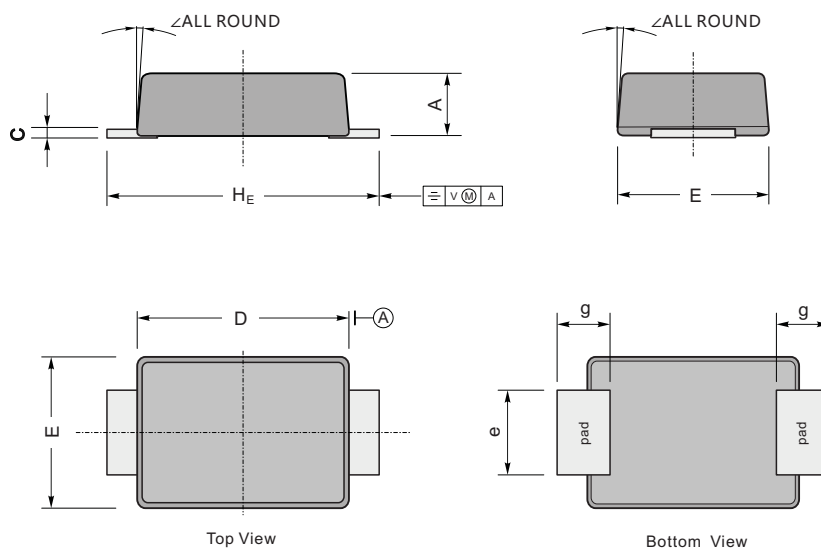


Fig.5- Typical Transient Thermal Impedance



PACKAGE OUTLINE

Plastic surface mounted package; 2 leads



UNIT		A	C	D	E	e	g	H _E	∠
mm	max	1.2	0.20	3.7	2.7	1.6	1.2	4.9	7°
	min	0.9	0.12	3.3	2.4	1.3	0.8	4.4	
mil	max	47	7.9	146	106	63	47	193	
	min	35	4.7	130	94	51	31	173	

The recommended mounting pad size

